

# Global Chip On Film Underfill (COF) Supply, Demand and Key Producers, 2026-2032

<https://marketpublishers.com/r/G7B8F93D2B70EN.html>

Date: February 2026

Pages: 148

Price: US\$ 4,480.00 (Single User License)

ID: G7B8F93D2B70EN

## Abstracts

The global Chip On Film Underfill (COF) market size is expected to reach \$ 670 million by 2032, rising at a market growth of 6.3% CAGR during the forecast period (2026-2032).

Chip On Film Underfill refers to underfill materials designed for chip on film packages where a die is mounted onto a flexible film carrier. Typical form factors include paste type underfills and film type non conductive films, most commonly based on epoxy chemistries with tailored curing systems, tougheners, and inorganic fillers. By filling and curing within the micro gaps between the die, the film substrate, and the interconnect region, COF underfill forms an electrically insulating, low moisture uptake, thermally robust solid that also mitigates interfacial stress. This enables higher assembly yield and improved long term reliability under thermal cycling, humidity exposure, mechanical shock, and bending loads. Applications are centered on display driver related packaging and module interconnects where higher resolution, narrower bezels, and flexible form factors demand fine gap filling, low voiding, and stable lifetime performance.

Manufacturing and supply are closely aligned with East Asian display and packaging ecosystems, while automotive and industrial display chains are increasingly adopting higher reliability grades.

In 2025, global shipments of Chip On Film Underfill materials for COF packages, including paste type underfills and film type solutions such as NCF, were reasonably estimated at about 1.6–2.6 thousand metric tons. On a manufacturer ex works basis approximating FOB, mainstream paste type COF underfill pricing typically fell around USD 120–220 per kg, while film type COF underfill generally commanded USD 260–600 per kg due to higher form factor and process integration requirements. On a blended, revenue weighted basis across major product types, the 2025 global average FOB price

was estimated at roughly USD 180–320 per kg.

From a global perspective, the value proposition of COF underfill is shifting from simple mechanical reinforcement to an integrated capability that stabilizes process windows and reliability at scale. As displays move toward thinner builds, higher pixel density, and more complex module integration, gaps tighten and takt times compress. Underfill materials must simultaneously deliver controlled flow and repeatable cure, low moisture uptake and strong electrical insulation, and effective stress management against thermo mechanical mismatch. These attributes translate directly into yield, rework, and lifetime cost, supporting more consistent adoption in mainstream display supply chains. In parallel, stricter automotive durability requirements in temperature and humidity cycling are accelerating demand for high temperature and high reliability underfills, pushing suppliers toward deeper co development with assembly lines around qualification metrics and manufacturing windows rather than stand alone material supply.

The key challenges and risks are driven by strong process coupling and qualification barriers. COF structures combine materials with markedly different thermo mechanical behavior, and insufficient control of flow, venting, and cure profiles can amplify voiding, delamination, and stress concentration during thermal cycling and bending, creating more complex failure modes. In addition, underfill formulations are often tightly matched to customer equipment settings, bonding pressure and temperature profiles, and the broader material stack, so reformulation or supplier switching can trigger re qualification cycles. Coupled with consistency and traceability requirements, this dynamic favors suppliers with proven mass production stability. Looking ahead, downstream demand is expected to concentrate further on routes that support finer gaps, higher throughput, and higher reliability thresholds. Film based and no flow compatible solutions should continue to gain penetration, while consumer and automotive display chains will show clearer performance tiers and pricing tiers aligned with reliability obligations.

This report studies the global Chip On Film Underfill (COF) production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Chip On Film Underfill (COF) and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of Chip On Film Underfill (COF) that contribute to its increasing demand across many markets.

## **Highlights and key features of the study**

Global Chip On Film Underfill (COF) total production and demand, 2021-2032, (MT)  
Global Chip On Film Underfill (COF) total production value, 2021-2032, (USD Million)  
Global Chip On Film Underfill (COF) production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (MT), (based on production site)  
Global Chip On Film Underfill (COF) consumption by region & country, CAGR, 2021-2032 & (MT)

U.S. VS China: Chip On Film Underfill (COF) domestic production, consumption, key domestic manufacturers and share  
Global Chip On Film Underfill (COF) production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (MT)  
Global Chip On Film Underfill (COF) production by Type, production, value, CAGR, 2021-2032, (USD Million) & (MT)  
Global Chip On Film Underfill (COF) production by Application, production, value, CAGR, 2021-2032, (USD Million) & (MT)

This report profiles key players in the global Chip On Film Underfill (COF) market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Darbond Technology Co., Ltd., Wuhan Choice Technology Co., Ltd., Dongguan Hanstars New Material Technology Co., Ltd., Shenzhen Dover Technology Co., Ltd., SDKY New Material Technology Co., Ltd., Henkel AG & Co. KGaA, NAMICS Corporation, Shin-Etsu Chemical Co., Ltd., FUJI CHEMICAL INDUSTRIAL CO., LTD., WON CHEMICAL Co., Ltd., etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Chip On Film Underfill (COF) market

### **Detailed Segmentation:**

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (MT) and average price (US\$/KG) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

### Global Chip On Film Underfill (COF) Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

### Global Chip On Film Underfill (COF) Market, Segmentation by Type:

Capillary Underfill (CUF)

Non-Conductive Paste (NCP)

Non-Conductive Film (NCF)

Others

### Global Chip On Film Underfill (COF) Market, Segmentation by Package Type:

Chip On Film (COF)

Wafer Level Chip Scale Package (WLCSP)

Others

### Global Chip On Film Underfill (COF) Market, Segmentation by Curing Process:

Thermal Cure

Ultraviolet (UV) Cure

Others

### Global Chip On Film Underfill (COF) Market, Segmentation by Material Chemistry:

Epoxy-Based Underfill

Silicone-Based Underfill

Others

### Global Chip On Film Underfill (COF) Market, Segmentation by Application:

Cell Phone

Tablet

LCD Display

Others

### Companies Profiled:

Darbond Technology Co., Ltd.

Wuhan Choice Technology Co., Ltd.

Dongguan Hanstars New Material Technology Co., Ltd.

Shenzhen Dover Technology Co., Ltd.

SDKY New Material Technology Co., Ltd.

Henkel AG & Co. KGaA

NAMICS Corporation

Shin-Etsu Chemical Co., Ltd.

FUJI CHEMICAL INDUSTRIAL CO., LTD.

WON CHEMICAL Co., Ltd.

Panasonic Industry Co., Ltd.

Dexerials Corporation

Parker Hannifin Corporation (Parker LORD)

Element Solutions Inc (MacDermid Alpha Electronics Solutions)

AIM Solder

Zymet

A.I. Technology, Inc.

Master Bond Inc.

Bondline Electronic Adhesives, Inc.

Panacol-Elosol GmbH

### **Key Questions Answered:**

1. How big is the global Chip On Film Underfill (COF) market?
2. What is the demand of the global Chip On Film Underfill (COF) market?
3. What is the year over year growth of the global Chip On Film Underfill (COF) market?
4. What is the production and production value of the global Chip On Film Underfill (COF) market?

5. Who are the key producers in the global Chip On Film Underfill (COF) market?
6. What are the growth factors driving the market demand?

## Contents

### 1 SUPPLY SUMMARY

- 1.1 Brik Shape Aseptic Packaging Introduction
- 1.2 World Brik Shape Aseptic Packaging Supply & Forecast
  - 1.2.1 World Brik Shape Aseptic Packaging Production Value (2021 & 2025 & 2032)
  - 1.2.2 World Brik Shape Aseptic Packaging Production (2021-2032)
  - 1.2.3 World Brik Shape Aseptic Packaging Pricing Trends (2021-2032)
- 1.3 World Brik Shape Aseptic Packaging Production by Region (Based on Production Site)
  - 1.3.1 World Brik Shape Aseptic Packaging Production Value by Region (2021-2032)
  - 1.3.2 World Brik Shape Aseptic Packaging Production by Region (2021-2032)
  - 1.3.3 World Brik Shape Aseptic Packaging Average Price by Region (2021-2032)
  - 1.3.4 North America Brik Shape Aseptic Packaging Production (2021-2032)
  - 1.3.5 Europe Brik Shape Aseptic Packaging Production (2021-2032)
  - 1.3.6 China Brik Shape Aseptic Packaging Production (2021-2032)
  - 1.3.7 Japan Brik Shape Aseptic Packaging Production (2021-2032)
  - 1.3.8 Southeast Asia Brik Shape Aseptic Packaging Production (2021-2032)
- 1.4 Market Drivers, Restraints and Trends
  - 1.4.1 Brik Shape Aseptic Packaging Market Drivers
  - 1.4.2 Factors Affecting Demand
  - 1.4.3 Brik Shape Aseptic Packaging Major Market Trends

### 2 DEMAND SUMMARY

- 2.1 World Brik Shape Aseptic Packaging Demand (2021-2032)
- 2.2 World Brik Shape Aseptic Packaging Consumption by Region
  - 2.2.1 World Brik Shape Aseptic Packaging Consumption by Region (2021-2026)
  - 2.2.2 World Brik Shape Aseptic Packaging Consumption Forecast by Region (2027-2032)
- 2.3 United States Brik Shape Aseptic Packaging Consumption (2021-2032)
- 2.4 China Brik Shape Aseptic Packaging Consumption (2021-2032)
- 2.5 Europe Brik Shape Aseptic Packaging Consumption (2021-2032)
- 2.6 Japan Brik Shape Aseptic Packaging Consumption (2021-2032)
- 2.7 South Korea Brik Shape Aseptic Packaging Consumption (2021-2032)
- 2.8 ASEAN Brik Shape Aseptic Packaging Consumption (2021-2032)
- 2.9 India Brik Shape Aseptic Packaging Consumption (2021-2032)

### **3 WORLD MANUFACTURERS COMPETITIVE ANALYSIS**

- 3.1 World Brik Shape Aseptic Packaging Production Value by Manufacturer (2021-2026)
- 3.2 World Brik Shape Aseptic Packaging Production by Manufacturer (2021-2026)
- 3.3 World Brik Shape Aseptic Packaging Average Price by Manufacturer (2021-2026)
- 3.4 Brik Shape Aseptic Packaging Company Evaluation Quadrant
- 3.5 Industry Rank and Concentration Rate (CR)
  - 3.5.1 Global Brik Shape Aseptic Packaging Industry Rank of Major Manufacturers
  - 3.5.2 Global Concentration Ratios (CR4) for Brik Shape Aseptic Packaging in 2025
  - 3.5.3 Global Concentration Ratios (CR8) for Brik Shape Aseptic Packaging in 2025
- 3.6 Brik Shape Aseptic Packaging Market: Overall Company Footprint Analysis
  - 3.6.1 Brik Shape Aseptic Packaging Market: Region Footprint
  - 3.6.2 Brik Shape Aseptic Packaging Market: Company Product Type Footprint
  - 3.6.3 Brik Shape Aseptic Packaging Market: Company Product Application Footprint
- 3.7 Competitive Environment
  - 3.7.1 Historical Structure of the Industry
  - 3.7.2 Barriers of Market Entry
  - 3.7.3 Factors of Competition
- 3.8 New Entrant and Capacity Expansion Plans
- 3.9 Mergers, Acquisition, Agreements, and Collaborations

### **4 UNITED STATES VS CHINA VS REST OF THE WORLD**

- 4.1 United States VS China: Brik Shape Aseptic Packaging Production Value Comparison
  - 4.1.1 United States VS China: Brik Shape Aseptic Packaging Production Value Comparison (2021 & 2025 & 2032)
  - 4.1.2 United States VS China: Brik Shape Aseptic Packaging Production Value Market Share Comparison (2021 & 2025 & 2032)
- 4.2 United States VS China: Brik Shape Aseptic Packaging Production Comparison
  - 4.2.1 United States VS China: Brik Shape Aseptic Packaging Production Comparison (2021 & 2025 & 2032)
  - 4.2.2 United States VS China: Brik Shape Aseptic Packaging Production Market Share Comparison (2021 & 2025 & 2032)
- 4.3 United States VS China: Brik Shape Aseptic Packaging Consumption Comparison
  - 4.3.1 United States VS China: Brik Shape Aseptic Packaging Consumption Comparison (2021 & 2025 & 2032)
  - 4.3.2 United States VS China: Brik Shape Aseptic Packaging Consumption Market

Share Comparison (2021 & 2025 & 2032)

4.4 United States Based Brik Shape Aseptic Packaging Manufacturers and Market Share, 2021-2026

4.4.1 United States Based Brik Shape Aseptic Packaging Manufacturers, Headquarters and Production Site (States, Country)

4.4.2 United States Based Manufacturers Brik Shape Aseptic Packaging Production Value (2021-2026)

4.4.3 United States Based Manufacturers Brik Shape Aseptic Packaging Production (2021-2026)

4.5 China Based Brik Shape Aseptic Packaging Manufacturers and Market Share

4.5.1 China Based Brik Shape Aseptic Packaging Manufacturers, Headquarters and Production Site (Province, Country)

4.5.2 China Based Manufacturers Brik Shape Aseptic Packaging Production Value (2021-2026)

4.5.3 China Based Manufacturers Brik Shape Aseptic Packaging Production (2021-2026)

4.6 Rest of World Based Brik Shape Aseptic Packaging Manufacturers and Market Share, 2021-2026

4.6.1 Rest of World Based Brik Shape Aseptic Packaging Manufacturers, Headquarters and Production Site (State, Country)

4.6.2 Rest of World Based Manufacturers Brik Shape Aseptic Packaging Production Value (2021-2026)

4.6.3 Rest of World Based Manufacturers Brik Shape Aseptic Packaging Production (2021-2026)

## **5 MARKET ANALYSIS BY TYPE**

5.1 World Brik Shape Aseptic Packaging Market Size Overview by Type: 2021 VS 2025 VS 2032

5.2 Segment Introduction by Type

5.2.1 500ml

5.3 Market Segment by Type

5.3.1 World Brik Shape Aseptic Packaging Production by Type (2021-2032)

5.3.2 World Brik Shape Aseptic Packaging Production Value by Type (2021-2032)

5.3.3 World Brik Shape Aseptic Packaging Average Price by Type (2021-2032)

## **6 MARKET ANALYSIS BY OPENING AND CLOSURE SYSTEM**

6.1 World Brik Shape Aseptic Packaging Market Size Overview by Opening and

Closure System: 2021 VS 2025 VS 2032

6.2 Segment Introduction by Opening and Closure System

6.2.1 Straw Hole Brik

6.2.2 Pull-Tab Opening Brik

6.2.3 Cap-Fitted Brik

6.3 Market Segment by Opening and Closure System

6.3.1 World Brik Shape Aseptic Packaging Production by Opening and Closure System (2021-2032)

6.3.2 World Brik Shape Aseptic Packaging Production Value by Opening and Closure System (2021-2032)

6.3.3 World Brik Shape Aseptic Packaging Average Price by Opening and Closure System (2021-2032)

## **7 MARKET ANALYSIS BY FORM**

7.1 World Brik Shape Aseptic Packaging Market Size Overview by Form: 2021 VS 2025 VS 2032

7.2 Segment Introduction by Form

7.2.1 Roll-Fed

7.2.2 Blank Fed

7.3 Market Segment by Form

7.3.1 World Brik Shape Aseptic Packaging Production by Form (2021-2032)

7.3.2 World Brik Shape Aseptic Packaging Production Value by Form (2021-2032)

7.3.3 World Brik Shape Aseptic Packaging Average Price by Form (2021-2032)

## **8 MARKET ANALYSIS BY APPLICATION**

8.1 World Brik Shape Aseptic Packaging Market Size Overview by Application: 2021 VS 2025 VS 2032

8.2 Segment Introduction by Application

8.2.1 Dairy

8.2.2 Beverage & Drinks

8.2.3 Others

8.3 Market Segment by Application

8.3.1 World Brik Shape Aseptic Packaging Production by Application (2021-2032)

8.3.2 World Brik Shape Aseptic Packaging Production Value by Application (2021-2032)

8.3.3 World Brik Shape Aseptic Packaging Average Price by Application (2021-2032)

## 9 COMPANY PROFILES

### 9.1 Tetra Pak

9.1.1 Tetra Pak Details

9.1.2 Tetra Pak Major Business

9.1.3 Tetra Pak Brik Shape Aseptic Packaging Product and Services

9.1.4 Tetra Pak Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.1.5 Tetra Pak Recent Developments/Updates

9.1.6 Tetra Pak Competitive Strengths & Weaknesses

### 9.2 SIG

9.2.1 SIG Details

9.2.2 SIG Major Business

9.2.3 SIG Brik Shape Aseptic Packaging Product and Services

9.2.4 SIG Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.2.5 SIG Recent Developments/Updates

9.2.6 SIG Competitive Strengths & Weaknesses

### 9.3 Elopak

9.3.1 Elopak Details

9.3.2 Elopak Major Business

9.3.3 Elopak Brik Shape Aseptic Packaging Product and Services

9.3.4 Elopak Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.3.5 Elopak Recent Developments/Updates

9.3.6 Elopak Competitive Strengths & Weaknesses

### 9.4 Pactiv Evergreen

9.4.1 Pactiv Evergreen Details

9.4.2 Pactiv Evergreen Major Business

9.4.3 Pactiv Evergreen Brik Shape Aseptic Packaging Product and Services

9.4.4 Pactiv Evergreen Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.4.5 Pactiv Evergreen Recent Developments/Updates

9.4.6 Pactiv Evergreen Competitive Strengths & Weaknesses

### 9.5 Greatview

9.5.1 Greatview Details

9.5.2 Greatview Major Business

9.5.3 Greatview Brik Shape Aseptic Packaging Product and Services

9.5.4 Greatview Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin

and Market Share (2021-2026)

9.5.5 Greatview Recent Developments/Updates

9.5.6 Greatview Competitive Strengths & Weaknesses

9.6 Lamipack

9.6.1 Lamipack Details

9.6.2 Lamipack Major Business

9.6.3 Lamipack Brik Shape Aseptic Packaging Product and Services

9.6.4 Lamipack Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.6.5 Lamipack Recent Developments/Updates

9.6.6 Lamipack Competitive Strengths & Weaknesses

9.7 Nippon Paper Industries

9.7.1 Nippon Paper Industries Details

9.7.2 Nippon Paper Industries Major Business

9.7.3 Nippon Paper Industries Brik Shape Aseptic Packaging Product and Services

9.7.4 Nippon Paper Industries Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.7.5 Nippon Paper Industries Recent Developments/Updates

9.7.6 Nippon Paper Industries Competitive Strengths & Weaknesses

9.8 Bihai

9.8.1 Bihai Details

9.8.2 Bihai Major Business

9.8.3 Bihai Brik Shape Aseptic Packaging Product and Services

9.8.4 Bihai Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.8.5 Bihai Recent Developments/Updates

9.8.6 Bihai Competitive Strengths & Weaknesses

9.9 Mondi Group

9.9.1 Mondi Group Details

9.9.2 Mondi Group Major Business

9.9.3 Mondi Group Brik Shape Aseptic Packaging Product and Services

9.9.4 Mondi Group Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.9.5 Mondi Group Recent Developments/Updates

9.9.6 Mondi Group Competitive Strengths & Weaknesses

9.10 SEMCORP

9.10.1 SEMCORP Details

9.10.2 SEMCORP Major Business

9.10.3 SEMCORP Brik Shape Aseptic Packaging Product and Services

9.10.4 SEMCORP Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.10.5 SEMCORP Recent Developments/Updates

9.10.6 SEMCORP Competitive Strengths & Weaknesses

9.11 Xinjufeng Pack

9.11.1 Xinjufeng Pack Details

9.11.2 Xinjufeng Pack Major Business

9.11.3 Xinjufeng Pack Brik Shape Aseptic Packaging Product and Services

9.11.4 Xinjufeng Pack Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.11.5 Xinjufeng Pack Recent Developments/Updates

9.11.6 Xinjufeng Pack Competitive Strengths & Weaknesses

9.12 Yingsheng

9.12.1 Yingsheng Details

9.12.2 Yingsheng Major Business

9.12.3 Yingsheng Brik Shape Aseptic Packaging Product and Services

9.12.4 Yingsheng Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.12.5 Yingsheng Recent Developments/Updates

9.12.6 Yingsheng Competitive Strengths & Weaknesses

9.13 ipack

9.13.1 ipack Details

9.13.2 ipack Major Business

9.13.3 ipack Brik Shape Aseptic Packaging Product and Services

9.13.4 ipack Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.13.5 ipack Recent Developments/Updates

9.13.6 ipack Competitive Strengths & Weaknesses

9.14 IPI

9.14.1 IPI Details

9.14.2 IPI Major Business

9.14.3 IPI Brik Shape Aseptic Packaging Product and Services

9.14.4 IPI Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.14.5 IPI Recent Developments/Updates

9.14.6 IPI Competitive Strengths & Weaknesses

9.15 Jielong Yongfa

9.15.1 Jielong Yongfa Details

9.15.2 Jielong Yongfa Major Business

- 9.15.3 Jielong Yongfa Brik Shape Aseptic Packaging Product and Services
- 9.15.4 Jielong Yongfa Brik Shape Aseptic Packaging Production, Price, Value, Gross Margin and Market Share (2021-2026)
- 9.15.5 Jielong Yongfa Recent Developments/Updates
- 9.15.6 Jielong Yongfa Competitive Strengths & Weaknesses

## **10 INDUSTRY CHAIN ANALYSIS**

- 10.1 Brik Shape Aseptic Packaging Industry Chain
- 10.2 Brik Shape Aseptic Packaging Upstream Analysis
  - 10.2.1 Brik Shape Aseptic Packaging Core Raw Materials
  - 10.2.2 Main Manufacturers of Brik Shape Aseptic Packaging Core Raw Materials
- 10.3 Midstream Analysis
- 10.4 Downstream Analysis
- 10.5 Brik Shape Aseptic Packaging Production Mode
- 10.6 Brik Shape Aseptic Packaging Procurement Model
- 10.7 Brik Shape Aseptic Packaging Industry Sales Model and Sales Channels
  - 10.7.1 Brik Shape Aseptic Packaging Sales Model
  - 10.7.2 Brik Shape Aseptic Packaging Typical Distributors

## **11 RESEARCH FINDINGS AND CONCLUSION**

## **12 APPENDIX**

- 12.1 Methodology
- 12.2 Research Process and Data Source
- 12.3 Disclaimer

## List Of Tables

### LIST OF TABLES

Table 1. World Chip On Film Underfill (COF) Production Value by Region (2021, 2025 and 2032) & (USD Million)

Table 2. World Chip On Film Underfill (COF) Production Value by Region (2021-2026) & (USD Million)

Table 3. World Chip On Film Underfill (COF) Production Value by Region (2027-2032) & (USD Million)

Table 4. World Chip On Film Underfill (COF) Production Value Market Share by Region (2021-2026)

Table 5. World Chip On Film Underfill (COF) Production Value Market Share by Region (2027-2032)

Table 6. World Chip On Film Underfill (COF) Production by Region (2021-2026) & (MT)

Table 7. World Chip On Film Underfill (COF) Production by Region (2027-2032) & (MT)

Table 8. World Chip On Film Underfill (COF) Production Market Share by Region (2021-2026)

Table 9. World Chip On Film Underfill (COF) Production Market Share by Region (2027-2032)

Table 10. World Chip On Film Underfill (COF) Average Price by Region (2021-2026) & (US\$/KG)

Table 11. World Chip On Film Underfill (COF) Average Price by Region (2027-2032) & (US\$/KG)

Table 12. Chip On Film Underfill (COF) Major Market Trends

Table 13. World Chip On Film Underfill (COF) Consumption Growth Rate Forecast by Region (2021 & 2025 & 2032) & (MT)

Table 14. World Chip On Film Underfill (COF) Consumption by Region (2021-2026) & (MT)

Table 15. World Chip On Film Underfill (COF) Consumption Forecast by Region (2027-2032) & (MT)

Table 16. World Chip On Film Underfill (COF) Production Value by Manufacturer (2021-2026) & (USD Million)

Table 17. Production Value Market Share of Key Chip On Film Underfill (COF) Producers in 2025

Table 18. World Chip On Film Underfill (COF) Production by Manufacturer (2021-2026) & (MT)

Table 19. Production Market Share of Key Chip On Film Underfill (COF) Producers in 2025

Table 20. World Chip On Film Underfill (COF) Average Price by Manufacturer (2021-2026) & (US\$/KG)

Table 21. Global Chip On Film Underfill (COF) Company Evaluation Quadrant

Table 22. World Chip On Film Underfill (COF) Industry Rank of Major Manufacturers, Based on Production Value in 2025

Table 23. Head Office and Chip On Film Underfill (COF) Production Site of Key Manufacturer

Table 24. Chip On Film Underfill (COF) Market: Company Product Type Footprint

Table 25. Chip On Film Underfill (COF) Market: Company Product Application Footprint

Table 26. Chip On Film Underfill (COF) Competitive Factors

Table 27. Chip On Film Underfill (COF) New Entrant and Capacity Expansion Plans

Table 28. Chip On Film Underfill (COF) Mergers & Acquisitions Activity

Table 29. United States VS China Chip On Film Underfill (COF) Production Value Comparison, (2021 & 2025 & 2032) & (USD Million)

Table 30. United States VS China Chip On Film Underfill (COF) Production Comparison, (2021 & 2025 & 2032) & (MT)

Table 31. United States VS China Chip On Film Underfill (COF) Consumption Comparison, (2021 & 2025 & 2032) & (MT)

Table 32. United States Based Chip On Film Underfill (COF) Manufacturers, Headquarters and Production Site (States, Country)

Table 33. United States Based Manufacturers Chip On Film Underfill (COF) Production Value, (2021-2026) & (USD Million)

Table 34. United States Based Manufacturers Chip On Film Underfill (COF) Production Value Market Share (2021-2026)

Table 35. United States Based Manufacturers Chip On Film Underfill (COF) Production (2021-2026) & (MT)

Table 36. United States Based Manufacturers Chip On Film Underfill (COF) Production Market Share (2021-2026)

Table 37. China Based Chip On Film Underfill (COF) Manufacturers, Headquarters and Production Site (Province, Country)

Table 38. China Based Manufacturers Chip On Film Underfill (COF) Production Value, (2021-2026) & (USD Million)

Table 39. China Based Manufacturers Chip On Film Underfill (COF) Production Value Market Share (2021-2026)

Table 40. China Based Manufacturers Chip On Film Underfill (COF) Production, (2021-2026) & (MT)

Table 41. China Based Manufacturers Chip On Film Underfill (COF) Production Market Share (2021-2026)

Table 42. Rest of World Based Chip On Film Underfill (COF) Manufacturers,

Headquarters and Production Site (State, Country)

Table 43. Rest of World Based Manufacturers Chip On Film Underfill (COF) Production Value, (2021-2026) & (USD Million)

Table 44. Rest of World Based Manufacturers Chip On Film Underfill (COF) Production Value Market Share (2021-2026)

Table 45. Rest of World Based Manufacturers Chip On Film Underfill (COF) Production, (2021-2026) & (MT)

Table 46. Rest of World Based Manufacturers Chip On Film Underfill (COF) Production Market Share (2021-2026)

Table 47. World Chip On Film Underfill (COF) Production Value by Type, (USD Million), 2021 & 2025 & 2032

Table 48. World Chip On Film Underfill (COF) Production by Type (2021-2026) & (MT)

Table 49. World Chip On Film Underfill (COF) Production by Type (2027-2032) & (MT)

Table 50. World Chip On Film Underfill (COF) Production Value by Type (2021-2026) & (USD Million)

Table 51. World Chip On Film Underfill (COF) Production Value by Type (2027-2032) & (USD Million)

Table 52. World Chip On Film Underfill (COF) Average Price by Type (2021-2026) & (US\$/KG)

Table 53. World Chip On Film Underfill (COF) Average Price by Type (2027-2032) & (US\$/KG)

Table 54. World Chip On Film Underfill (COF) Production Value by Package Type, (USD Million), 2021 & 2025 & 2032

Table 55. World Chip On Film Underfill (COF) Production by Package Type (2021-2026) & (MT)

Table 56. World Chip On Film Underfill (COF) Production by Package Type (2027-2032) & (MT)

Table 57. World Chip On Film Underfill (COF) Production Value by Package Type (2021-2026) & (USD Million)

Table 58. World Chip On Film Underfill (COF) Production Value by Package Type (2027-2032) & (USD Million)

Table 59. World Chip On Film Underfill (COF) Average Price by Package Type (2021-2026) & (US\$/KG)

Table 60. World Chip On Film Underfill (COF) Average Price by Package Type (2027-2032) & (US\$/KG)

Table 61. World Chip On Film Underfill (COF) Production Value by Curing Process, (USD Million), 2021 & 2025 & 2032

Table 62. World Chip On Film Underfill (COF) Production by Curing Process (2021-2026) & (MT)

- Table 63. World Chip On Film Underfill (COF) Production by Curing Process (2027-2032) & (MT)
- Table 64. World Chip On Film Underfill (COF) Production Value by Curing Process (2021-2026) & (USD Million)
- Table 65. World Chip On Film Underfill (COF) Production Value by Curing Process (2027-2032) & (USD Million)
- Table 66. World Chip On Film Underfill (COF) Average Price by Curing Process (2021-2026) & (US\$/KG)
- Table 67. World Chip On Film Underfill (COF) Average Price by Curing Process (2027-2032) & (US\$/KG)
- Table 68. World Chip On Film Underfill (COF) Production Value by Material Chemistry, (USD Million), 2021 & 2025 & 2032
- Table 69. World Chip On Film Underfill (COF) Production by Material Chemistry (2021-2026) & (MT)
- Table 70. World Chip On Film Underfill (COF) Production by Material Chemistry (2027-2032) & (MT)
- Table 71. World Chip On Film Underfill (COF) Production Value by Material Chemistry (2021-2026) & (USD Million)
- Table 72. World Chip On Film Underfill (COF) Production Value by Material Chemistry (2027-2032) & (USD Million)
- Table 73. World Chip On Film Underfill (COF) Average Price by Material Chemistry (2021-2026) & (US\$/KG)
- Table 74. World Chip On Film Underfill (COF) Average Price by Material Chemistry (2027-2032) & (US\$/KG)
- Table 75. World Chip On Film Underfill (COF) Production Value by Application, (USD Million), 2021 & 2025 & 2032
- Table 76. World Chip On Film Underfill (COF) Production by Application (2021-2026) & (MT)
- Table 77. World Chip On Film Underfill (COF) Production by Application (2027-2032) & (MT)
- Table 78. World Chip On Film Underfill (COF) Production Value by Application (2021-2026) & (USD Million)
- Table 79. World Chip On Film Underfill (COF) Production Value by Application (2027-2032) & (USD Million)
- Table 80. World Chip On Film Underfill (COF) Average Price by Application (2021-2026) & (US\$/KG)
- Table 81. World Chip On Film Underfill (COF) Average Price by Application (2027-2032) & (US\$/KG)
- Table 82. Darbond Technology Co., Ltd. Basic Information, Manufacturing Base and

## Competitors

Table 83. Darbond Technology Co., Ltd. Major Business

Table 84. Darbond Technology Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 85. Darbond Technology Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 86. Darbond Technology Co., Ltd. Recent Developments/Updates

Table 87. Darbond Technology Co., Ltd. Competitive Strengths & Weaknesses

Table 88. Wuhan Choice Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 89. Wuhan Choice Technology Co., Ltd. Major Business

Table 90. Wuhan Choice Technology Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 91. Wuhan Choice Technology Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 92. Wuhan Choice Technology Co., Ltd. Recent Developments/Updates

Table 93. Wuhan Choice Technology Co., Ltd. Competitive Strengths & Weaknesses

Table 94. Dongguan Hanstars New Material Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 95. Dongguan Hanstars New Material Technology Co., Ltd. Major Business

Table 96. Dongguan Hanstars New Material Technology Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 97. Dongguan Hanstars New Material Technology Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 98. Dongguan Hanstars New Material Technology Co., Ltd. Recent Developments/Updates

Table 99. Dongguan Hanstars New Material Technology Co., Ltd. Competitive Strengths & Weaknesses

Table 100. Shenzhen Dover Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 101. Shenzhen Dover Technology Co., Ltd. Major Business

Table 102. Shenzhen Dover Technology Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 103. Shenzhen Dover Technology Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 104. Shenzhen Dover Technology Co., Ltd. Recent Developments/Updates

Table 105. Shenzhen Dover Technology Co., Ltd. Competitive Strengths & Weaknesses

Table 106. SDKY New Material Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 107. SDKY New Material Technology Co., Ltd. Major Business

Table 108. SDKY New Material Technology Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 109. SDKY New Material Technology Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 110. SDKY New Material Technology Co., Ltd. Recent Developments/Updates

Table 111. SDKY New Material Technology Co., Ltd. Competitive Strengths & Weaknesses

Table 112. Henkel AG & Co. KGaA Basic Information, Manufacturing Base and Competitors

Table 113. Henkel AG & Co. KGaA Major Business

Table 114. Henkel AG & Co. KGaA Chip On Film Underfill (COF) Product and Services

Table 115. Henkel AG & Co. KGaA Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 116. Henkel AG & Co. KGaA Recent Developments/Updates

Table 117. Henkel AG & Co. KGaA Competitive Strengths & Weaknesses

Table 118. NAMICS Corporation Basic Information, Manufacturing Base and Competitors

Table 119. NAMICS Corporation Major Business

Table 120. NAMICS Corporation Chip On Film Underfill (COF) Product and Services

Table 121. NAMICS Corporation Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 122. NAMICS Corporation Recent Developments/Updates

Table 123. NAMICS Corporation Competitive Strengths & Weaknesses

Table 124. Shin-Etsu Chemical Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 125. Shin-Etsu Chemical Co., Ltd. Major Business

Table 126. Shin-Etsu Chemical Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 127. Shin-Etsu Chemical Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share

(2021-2026)

Table 128. Shin-Etsu Chemical Co., Ltd. Recent Developments/Updates

Table 129. Shin-Etsu Chemical Co., Ltd. Competitive Strengths & Weaknesses

Table 130. FUJI CHEMICAL INDUSTRIAL CO., LTD. Basic Information, Manufacturing Base and Competitors

Table 131. FUJI CHEMICAL INDUSTRIAL CO., LTD. Major Business

Table 132. FUJI CHEMICAL INDUSTRIAL CO., LTD. Chip On Film Underfill (COF) Product and Services

Table 133. FUJI CHEMICAL INDUSTRIAL CO., LTD. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 134. FUJI CHEMICAL INDUSTRIAL CO., LTD. Recent Developments/Updates

Table 135. FUJI CHEMICAL INDUSTRIAL CO., LTD. Competitive Strengths & Weaknesses

Table 136. WON CHEMICAL Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 137. WON CHEMICAL Co., Ltd. Major Business

Table 138. WON CHEMICAL Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 139. WON CHEMICAL Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 140. WON CHEMICAL Co., Ltd. Recent Developments/Updates

Table 141. WON CHEMICAL Co., Ltd. Competitive Strengths & Weaknesses

Table 142. Panasonic Industry Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 143. Panasonic Industry Co., Ltd. Major Business

Table 144. Panasonic Industry Co., Ltd. Chip On Film Underfill (COF) Product and Services

Table 145. Panasonic Industry Co., Ltd. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 146. Panasonic Industry Co., Ltd. Recent Developments/Updates

Table 147. Panasonic Industry Co., Ltd. Competitive Strengths & Weaknesses

Table 148. Dexerials Corporation Basic Information, Manufacturing Base and Competitors

Table 149. Dexerials Corporation Major Business

Table 150. Dexerials Corporation Chip On Film Underfill (COF) Product and Services

Table 151. Dexerials Corporation Chip On Film Underfill (COF) Production (MT), Price

(US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 152. Dexerials Corporation Recent Developments/Updates

Table 153. Dexerials Corporation Competitive Strengths & Weaknesses

Table 154. Parker Hannifin Corporation (Parker LORD) Basic Information, Manufacturing Base and Competitors

Table 155. Parker Hannifin Corporation (Parker LORD) Major Business

Table 156. Parker Hannifin Corporation (Parker LORD) Chip On Film Underfill (COF) Product and Services

Table 157. Parker Hannifin Corporation (Parker LORD) Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 158. Parker Hannifin Corporation (Parker LORD) Recent Developments/Updates

Table 159. Parker Hannifin Corporation (Parker LORD) Competitive Strengths & Weaknesses

Table 160. Element Solutions Inc (MacDermid Alpha Electronics Solutions) Basic Information, Manufacturing Base and Competitors

Table 161. Element Solutions Inc (MacDermid Alpha Electronics Solutions) Major Business

Table 162. Element Solutions Inc (MacDermid Alpha Electronics Solutions) Chip On Film Underfill (COF) Product and Services

Table 163. Element Solutions Inc (MacDermid Alpha Electronics Solutions) Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 164. Element Solutions Inc (MacDermid Alpha Electronics Solutions) Recent Developments/Updates

Table 165. Element Solutions Inc (MacDermid Alpha Electronics Solutions) Competitive Strengths & Weaknesses

Table 166. AIM Solder Basic Information, Manufacturing Base and Competitors

Table 167. AIM Solder Major Business

Table 168. AIM Solder Chip On Film Underfill (COF) Product and Services

Table 169. AIM Solder Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 170. AIM Solder Recent Developments/Updates

Table 171. AIM Solder Competitive Strengths & Weaknesses

Table 172. Zymet Basic Information, Manufacturing Base and Competitors

Table 173. Zymet Major Business

Table 174. Zymet Chip On Film Underfill (COF) Product and Services

Table 175. Zymet Chip On Film Underfill (COF) Production (MT), Price (US\$/KG),

Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 176. Zymet Recent Developments/Updates

Table 177. Zymet Competitive Strengths & Weaknesses

Table 178. A.I. Technology, Inc. Basic Information, Manufacturing Base and Competitors

Table 179. A.I. Technology, Inc. Major Business

Table 180. A.I. Technology, Inc. Chip On Film Underfill (COF) Product and Services

Table 181. A.I. Technology, Inc. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 182. A.I. Technology, Inc. Recent Developments/Updates

Table 183. A.I. Technology, Inc. Competitive Strengths & Weaknesses

Table 184. Master Bond Inc. Basic Information, Manufacturing Base and Competitors

Table 185. Master Bond Inc. Major Business

Table 186. Master Bond Inc. Chip On Film Underfill (COF) Product and Services

Table 187. Master Bond Inc. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 188. Master Bond Inc. Recent Developments/Updates

Table 189. Master Bond Inc. Competitive Strengths & Weaknesses

Table 190. Bondline Electronic Adhesives, Inc. Basic Information, Manufacturing Base and Competitors

Table 191. Bondline Electronic Adhesives, Inc. Major Business

Table 192. Bondline Electronic Adhesives, Inc. Chip On Film Underfill (COF) Product and Services

Table 193. Bondline Electronic Adhesives, Inc. Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 194. Bondline Electronic Adhesives, Inc. Recent Developments/Updates

Table 195. Bondline Electronic Adhesives, Inc. Competitive Strengths & Weaknesses

Table 196. Panacol-Elosol GmbH Basic Information, Manufacturing Base and Competitors

Table 197. Panacol-Elosol GmbH Major Business

Table 198. Panacol-Elosol GmbH Chip On Film Underfill (COF) Product and Services

Table 199. Panacol-Elosol GmbH Chip On Film Underfill (COF) Production (MT), Price (US\$/KG), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 200. Panacol-Elosol GmbH Recent Developments/Updates

Table 201. Panacol-Elosol GmbH Competitive Strengths & Weaknesses

Table 202. Global Key Players of Chip On Film Underfill (COF) Upstream (Raw Materials)

Table 203. Global Chip On Film Underfill (COF) Typical Customers

Table 204. Chip On Film Underfill (COF) Typical Distributors

## List Of Figures

### LIST OF FIGURES

Figure 1. Chip On Film Underfill (COF) Picture

Figure 2. World Chip On Film Underfill (COF) Production Value: 2021 & 2025 & 2032, (USD Million)

Figure 3. World Chip On Film Underfill (COF) Production Value and Forecast (2021-2032) & (USD Million)

Figure 4. World Chip On Film Underfill (COF) Production (2021-2032) & (MT)

Figure 5. World Chip On Film Underfill (COF) Average Price (2021-2032) & (US\$/KG)

Figure 6. World Chip On Film Underfill (COF) Production Value Market Share by Region (2021-2032)

Figure 7. World Chip On Film Underfill (COF) Production Market Share by Region (2021-2032)

Figure 8. North America Chip On Film Underfill (COF) Production (2021-2032) & (MT)

Figure 9. Europe Chip On Film Underfill (COF) Production (2021-2032) & (MT)

Figure 10. China Chip On Film Underfill (COF) Production (2021-2032) & (MT)

Figure 11. Japan Chip On Film Underfill (COF) Production (2021-2032) & (MT)

Figure 12. Chip On Film Underfill (COF) Market Drivers

Figure 13. Factors Affecting Demand

Figure 14. World Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 15. World Chip On Film Underfill (COF) Consumption Market Share by Region (2021-2032)

Figure 16. United States Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 17. China Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 18. Europe Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 19. Japan Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 20. South Korea Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 21. ASEAN Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 22. India Chip On Film Underfill (COF) Consumption (2021-2032) & (MT)

Figure 23. Producer Shipments of Chip On Film Underfill (COF) by Manufacturer Revenue (\$MM) and Market Share (%): 2025

Figure 24. Global Four-firm Concentration Ratios (CR4) for Chip On Film Underfill (COF) Markets in 2025

Figure 25. Global Four-firm Concentration Ratios (CR8) for Chip On Film Underfill (COF) Markets in 2025

Figure 26. United States VS China: Chip On Film Underfill (COF) Production Value

Market Share Comparison (2021 & 2025 & 2032)

Figure 27. United States VS China: Chip On Film Underfill (COF) Production Market Share Comparison (2021 & 2025 & 2032)

Figure 28. United States VS China: Chip On Film Underfill (COF) Consumption Market Share Comparison (2021 & 2025 & 2032)

Figure 29. United States Based Manufacturers Chip On Film Underfill (COF) Production Market Share 2025

Figure 30. China Based Manufacturers Chip On Film Underfill (COF) Production Market Share 2025

Figure 31. Rest of World Based Manufacturers Chip On Film Underfill (COF) Production Market Share 2025

Figure 32. World Chip On Film Underfill (COF) Production Value by Type, (USD Million), 2021 & 2025 & 2032

Figure 33. World Chip On Film Underfill (COF) Production Value Market Share by Type in 2025

Figure 34. Capillary Underfill (CUF)

Figure 35. Non-Conductive Paste (NCP)

Figure 36. Non-Conductive Film (NCF)

Figure 37. Others

Figure 38. World Chip On Film Underfill (COF) Production Market Share by Type (2021-2032)

Figure 39. World Chip On Film Underfill (COF) Production Value Market Share by Type (2021-2032)

Figure 40. World Chip On Film Underfill (COF) Average Price by Type (2021-2032) & (US\$/KG)

Figure 41. World Chip On Film Underfill (COF) Production Value by Package Type, (USD Million), 2021 & 2025 & 2032

Figure 42. World Chip On Film Underfill (COF) Production Value Market Share by Package Type in 2025

Figure 43. Chip On Film (COF)

Figure 44. Wafer Level Chip Scale Package (WLCSP)

Figure 45. Others

Figure 46. World Chip On Film Underfill (COF) Production Market Share by Package Type (2021-2032)

Figure 47. World Chip On Film Underfill (COF) Production Value Market Share by Package Type (2021-2032)

Figure 48. World Chip On Film Underfill (COF) Average Price by Package Type (2021-2032) & (US\$/KG)

Figure 49. World Chip On Film Underfill (COF) Production Value by Curing Process,

(USD Million), 2021 & 2025 & 2032

Figure 50. World Chip On Film Underfill (COF) Production Value Market Share by Curing Process in 2025

Figure 51. Thermal Cure

Figure 52. Ultraviolet (UV) Cure

Figure 53. Others

Figure 54. World Chip On Film Underfill (COF) Production Market Share by Curing Process (2021-2032)

Figure 55. World Chip On Film Underfill (COF) Production Value Market Share by Curing Process (2021-2032)

Figure 56. World Chip On Film Underfill (COF) Average Price by Curing Process (2021-2032) & (US\$/KG)

Figure 57. World Chip On Film Underfill (COF) Production Value by Material Chemistry, (USD Million), 2021 & 2025 & 2032

Figure 58. World Chip On Film Underfill (COF) Production Value Market Share by Material Chemistry in 2025

Figure 59. Epoxy-Based Underfill

Figure 60. Silicone-Based Underfill

Figure 61. Others

Figure 62. World Chip On Film Underfill (COF) Production Market Share by Material Chemistry (2021-2032)

Figure 63. World Chip On Film Underfill (COF) Production Value Market Share by Material Chemistry (2021-2032)

Figure 64. World Chip On Film Underfill (COF) Average Price by Material Chemistry (2021-2032) & (US\$/KG)

Figure 65. World Chip On Film Underfill (COF) Production Value by Application, (USD Million), 2021 & 2025 & 2032

Figure 66. World Chip On Film Underfill (COF) Production Value Market Share by Application in 2025

Figure 67. Cell Phone

Figure 68. Tablet

Figure 69. LCD Display

Figure 70. Others

Figure 71. World Chip On Film Underfill (COF) Production Market Share by Application (2021-2032)

Figure 72. World Chip On Film Underfill (COF) Production Value Market Share by Application (2021-2032)

Figure 73. World Chip On Film Underfill (COF) Average Price by Application (2021-2032) & (US\$/KG)

Figure 74. Chip On Film Underfill (COF) Industry Chain

Figure 75. Chip On Film Underfill (COF) Procurement Model

Figure 76. Chip On Film Underfill (COF) Sales Model

Figure 77. Chip On Film Underfill (COF) Sales Channels, Direct Sales, and Distribution

Figure 78. Methodology

Figure 79. Research Process and Data Source

## I would like to order

Product name: Global Chip On Film Underfill (COF) Supply, Demand and Key Producers, 2026-2032

Product link: <https://marketpublishers.com/r/G7B8F93D2B70EN.html>

Price: US\$ 4,480.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

[info@marketpublishers.com](mailto:info@marketpublishers.com)

## Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/G7B8F93D2B70EN.html>